imall

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Panasonic

Transistors with Built-in Resistor DRA2514E0L

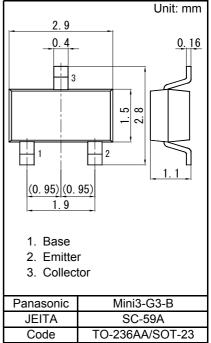
DRA2514E0L Silicon PNP epitaxial planar type

For digital circuit Complementary to DRC2514E

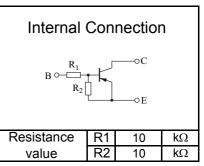
Features

- Low collector-emitter saturation voltage Vce(sat)
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: UZ
- Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)



Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	VCBO	-50	V
Collector-emitter voltage (Base open)	VCEO	-50	V
Collector current	IC	-500	mA
Total power dissipation	PT	200	mW
Junction temperature	Tj	150	°C
Operating ambient temperature	Topr	-40 to +85	°C
Storage temperature	Tstg	-55 to +150	°C



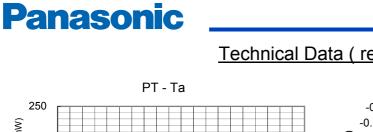
■ Electrical Characteristics Ta = 25 °C ± 3 °C

■ Absolute Maximum Ratings Ta = 25 °C

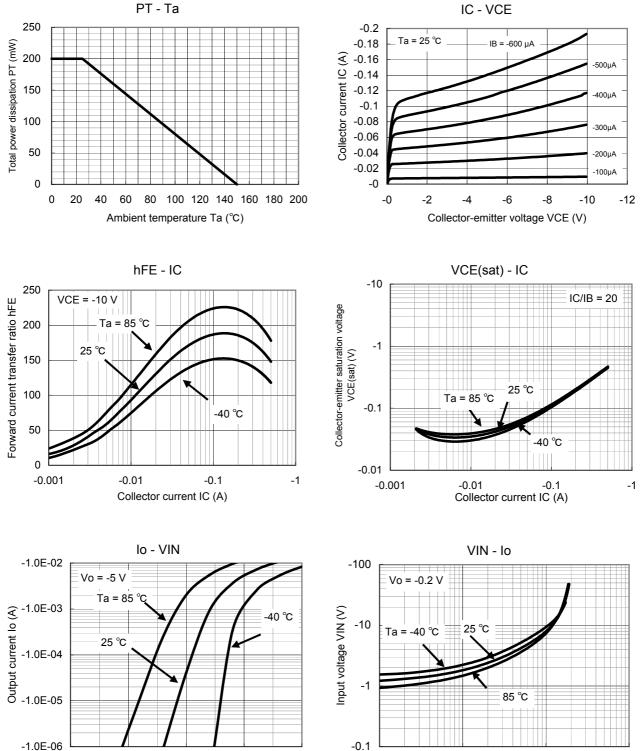
Parameter	Symbol	Conditions	Min	Тур	Max	Unit		
Collector-base voltage (Emitter open)	VCBO	IC = -10 μA, IE = 0	-50			V		
Collector-emitter voltage (Base open)	VCEO	IC = -2 mA, IB = 0	-50			V		
Collector-base cutoff current (Emitter open)	ICBO	VCB = -50 V, IE = 0			-1	μA		
Collector-emitter cutoff current (Base open)	ICEO	VCE = -50 V, IB = 0			-1	μA		
Emitter-base cutoff current (Collector open)	IEBO	VEB = -6 V, IC = 0			-1	mA		
Forward current transfer ratio	hFE	VCE = -10 V, IC = -100 mA	60			-		
Collector-emitter saturation voltage	VCE(sat)	,			-0.25	V		
Input voltage	Vi(on)	VCE = -0.2 V, IC = -50 mA	-5.7			V		
	Vi(off)	VCE = -5 V, IC = -100 µA			-0.7	V		
Input resistance	R1		-30%	10	+30%	kΩ		
Resistance ratio	R1/R2		0.8	1.0	1.2	-		

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

Transistors with Built-in Resistor **DRA2514E0L**



Technical Data (reference)



-1

-0.1

Established : 2010-02-04 Revised : 2014-01-22

-0

-0.5

-1

Input voltage VIN (V)

-1.5

-2

-0.001

-0.01

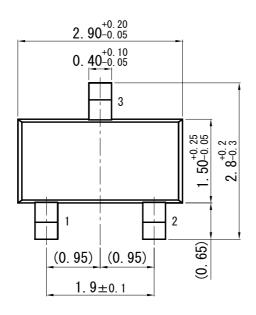
Output current Io (A)

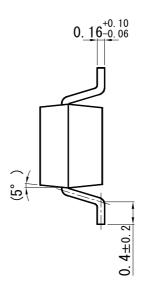


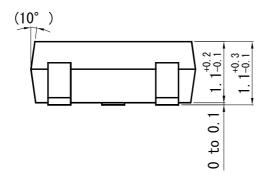
Transistors with Built-in Resistor DRA2514E0L

Mini3-G3-B

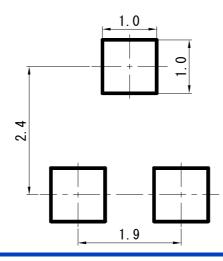
Unit: mm







Land Pattern (Reference) (Unit: mm)



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Established : 2010-02-04 Revised : 2014-01-22

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